

● General Description

It combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

● Features

- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

● Application

- BLDC Motor driver
- DC-DC
- Load switch

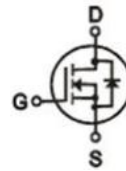
● Ordering Information:

Part NO.	ZMS030N06P
Marking	ZMS030N06
Packing Information	Bulk Tube
Basic ordering unit (pcs)	1000

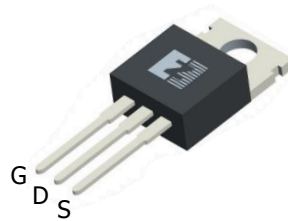
● Absolute Maximum Ratings ( $T_C=25^{\circ}C$ )

Parameter	Symbol	Conditions	Value	Unit
Drain-Source Voltage	$V_{DS}$	$25^{\circ}C \leq T_J \leq 175^{\circ}C$	60	V
Gate-Source Voltage <sup>①</sup>	$V_{GS}$		$\pm 20$	V
Continuous Drain Current	$I_D$	$T_C=25^{\circ}C$	140	A
	$I_D$	$T_C=75^{\circ}C$	114	A
	$I_D$	$T_C=100^{\circ}C$	99	A
Pulsed Drain Current	$I_{DM}$	Pulsed; $t_p \leq 10 \mu s$ ; $T_{mb} = 25^{\circ}C$ ;	560	A
Total Power Dissipation	$P_D$	$T_C=25^{\circ}C$	125	W
Total Power Dissipation	$P_D$	$T_A=25^{\circ}C$	3.3	W
Operating Junction Temperature	$T_J$		-55 to +175	$^{\circ}C$
Storage Temperature	$T_{STG}$		-55 to +175	$^{\circ}C$
Single Pulse Avalanche Energy	$E_{AS}$	L=0.1mH, VGS=10V, Rg=25 $\Omega$ ,	190	mJ
		L=0.5mH, VGS=10V, Rg=25 $\Omega$ ,	399	mJ
ESD Level (HBM)	CLASS 2			

● Product Summary



$V_{DS} = 60V$   
 $R_{DS(ON)} = 2.6m\Omega$   
 $I_D = 140A$



TO-220



**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	$R_{thJC}$		-	1.2	°C/W
Thermal resistance, junction-ambient <sup>②</sup>	$R_{thJA}$		-	45	°C/W
Soldering temperature (total time<10s)	Tsold		-	260	°C

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.4	1.7	2.5	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{GS}=0V, V_{DS}=60V$			1.0	$\mu A$
Gate- Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$			100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=30A$		2.6	3.5	m $\Omega$
		$V_{GS}=4.5V, I_D=20A$		3.4	4.5	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{GS}=5V, I_{SD}=10A$		25		S
Diode Forward Voltage	$V_{FSD}$	$V_{GS}=0V, I_{SD}=30A$			1.3	V

**•Dynamic characteristics**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	$C_{iss}$	$f=1MHz, V_{DS}=25V$	-	4090	-	pF
Output capacitance	$C_{oss}$		-	1750	-	
Reverse transfer capacitance	$C_{rss}$		-	80	-	
Gate Resistance	$R_g$	$f=1MHz$	-	1.9		$\Omega$
Total gate charge	$Q_g$	$V_{DD}=15V, I_D=20A, V_{GS}=10V$	-	67	-	nC
	$Q_g(4.5V)$		-	32	-	
Gate - Source charge	$Q_{gs}$		-	15	-	
Gate - Drain charge	$Q_{gd}$		-	10	-	
Turn-ON Delay time	$t_{D(on)}$		$V_{GS}=10V, V_{DS}=15V, R_G=3.3\Omega, I_D=20A$	-	4.7	
Turn-ON Rise time	$t_r$	-		26	-	ns
Turn-Off Delay time	$t_{D(off)}$	-		1.3	-	ns
Turn-Off Fall time	$t_f$	-		10.5	-	ns
Reverse Recovery Time	$t_{RR}$	$V_{DD}=20V, dI_S/dt=100A/\mu s, I_S=20A$	-	52	-	ns
Reverse Recovery Charge	$Q_{RR}$		-	49	-	nC

Fig.1 Gate-Charge Characteristics

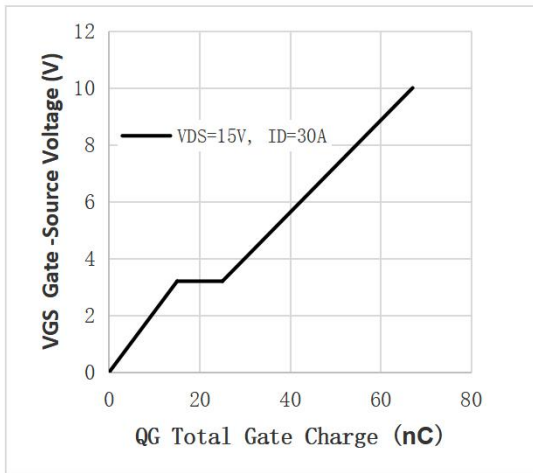


Fig.2 Capacitance Characteristics

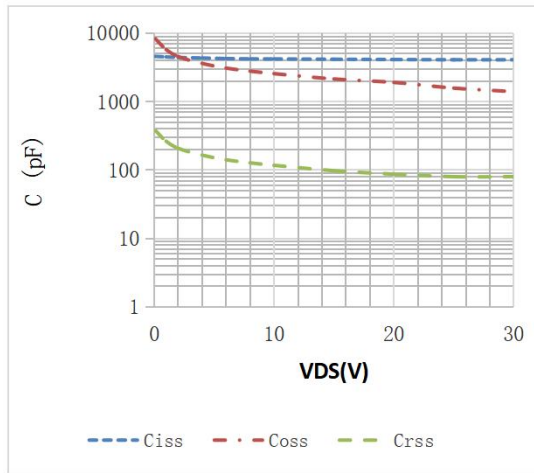


Fig.3 Power Dissipation

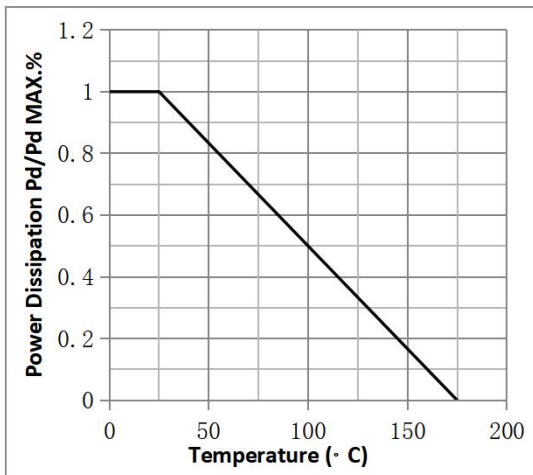


Fig.4 Typical output Characteristics

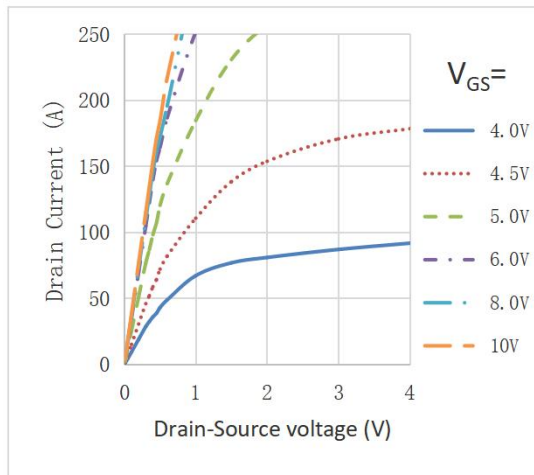


Fig.5 Threshold Voltage V.S Junction Temperature

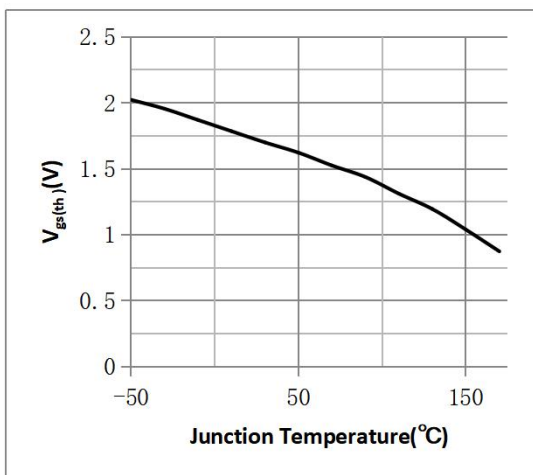


Fig.6 Resistance V.S Drain Current

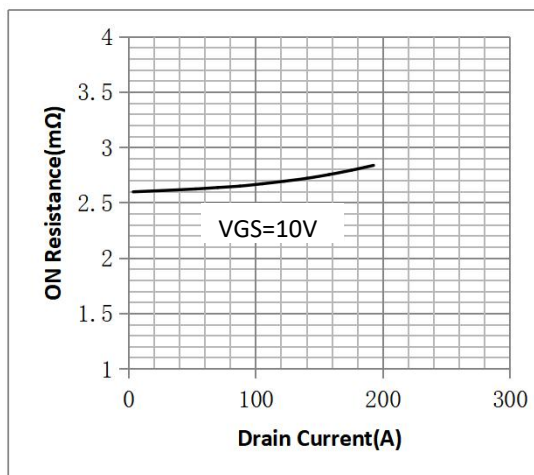


Fig.7 On-Resistance VS Gate Source Voltage

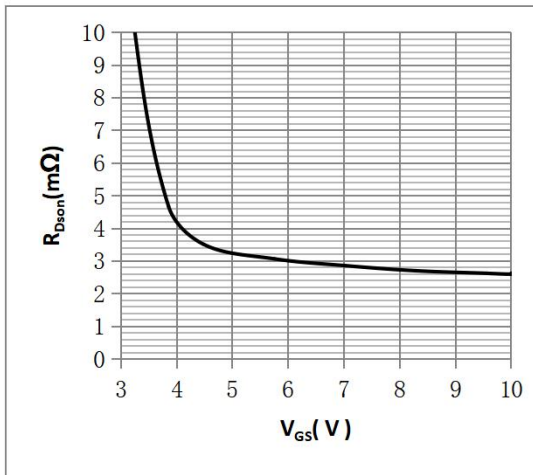


Fig.8 On-Resistance V.S Junction Temperature

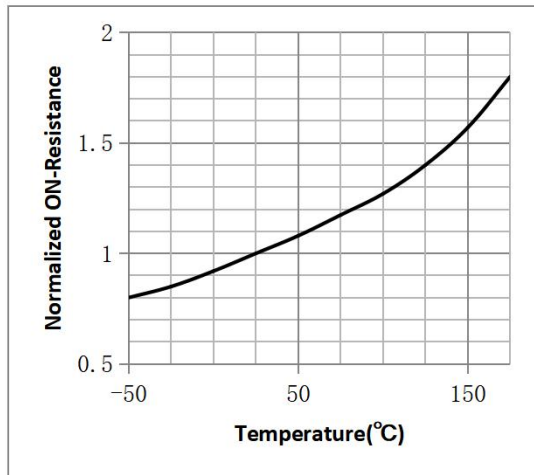


Figure 9. Diode Forward Voltage vs. Current

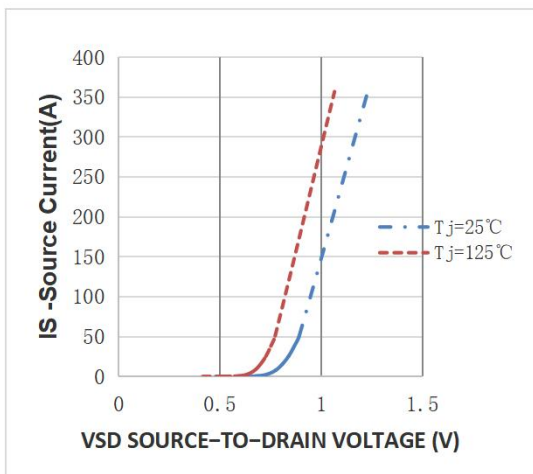


Figure 10. Transfer Characteristics

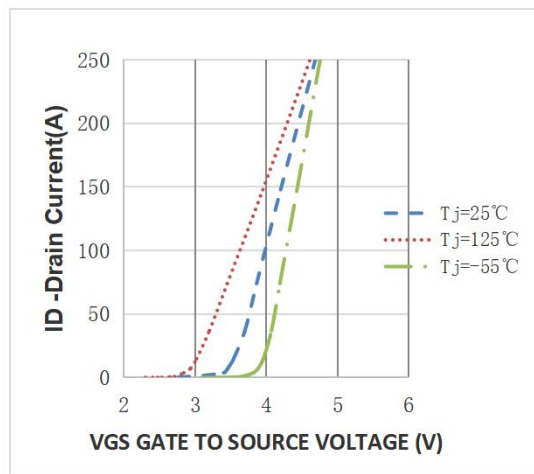


Fig.11 SOA Maximum Safe Operating Area

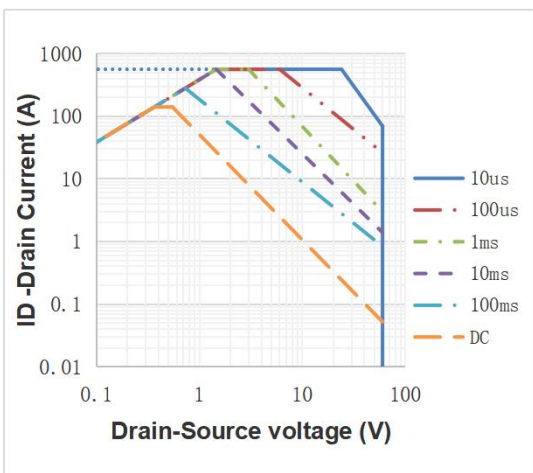
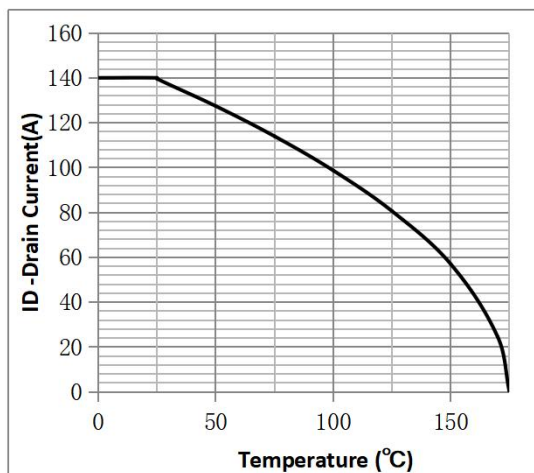
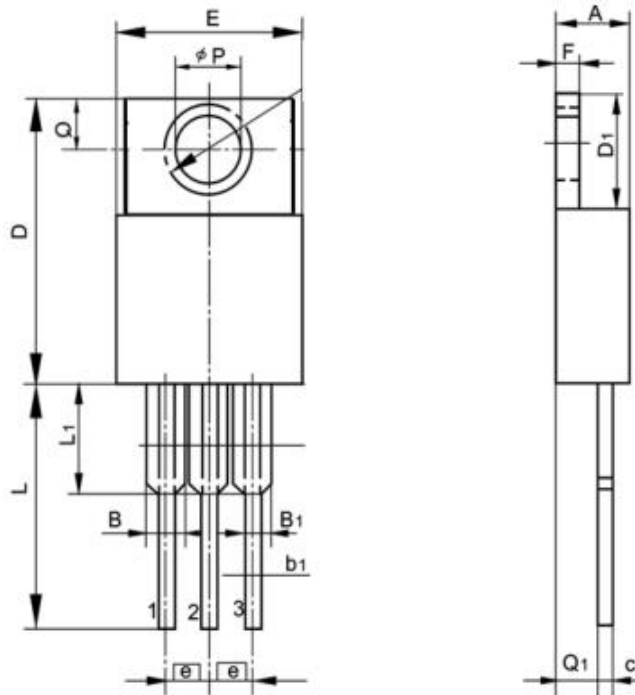


Fig.12 ID vs. Case Temperature<sup>③</sup>



•TO-220 Package Outline

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	4.00		4.80	E	9.90		10.70
B	1.20		1.50	e		2.54	
B1	1.00		1.40	F	1.10		1.45
b1	0.65		1.00	L	12.50		14.50
c	0.35		0.75	L1	3.00	3.50	4.00
D	15.00		16.50	Q	2.50		3.00
D1	5.90		6.90	Q1	2.00		3.00
				ΦP	3.60		3.90



**Note:**

- ① Pulse : VGS=+20V/-20V, Duty cycle=50%, T<sub>j</sub>=175°C, t=1000 hours; For DC , the following test conditions can be passed: VGS=+20V/-10V, T<sub>j</sub>=175°C, t=1000 hours;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ③ Practically the current will be limited by PCB, thermal design and operating temperature. VGS=10V.

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Revision History

Version	Date	Change
A	2021.11.10	NEW
B	2022.9.3	1.Add Dynamic characteristics 2.Modify id curve